



ENGINEERING DEPT.		PRODUCT SPECIFICATION For CF41 Series Connector System	SPEC.NO.: SPCF062B
REVISIONS	ECNT120150		PAGE: 1/4

1. SCOPE:

This specification contains the test requirement of subject connectors when tested under the condition and inserted on the specified size FPC and FFC

2. APPLICABLE STANDARDS:

MIL - STD - 202	Methods for test of connectors for electronic equipment
EIA-364	Test methods for electrical connectors
J-STD-020	Resistance to soldering Temperature for through hole Mounted Devices
SS-00254	Test methods for electronic components ,LEAD-FREE soldering Part design standards

3. APPLICABLE SERIES NO.: **CF41 Series**

4. SHAPE, CONSTRUCTION AND DIMENSIONS

See attached drawings

5. MATERIALS

See attached drawings

6. ACCOMMODATED P.C.BOARD

6.1 Thickness: 0.5 mm (.020") ~ 2.0 mm (.079")

6.2 P.C. Board Layout: See attached drawings

7. ACCOMMODATED FPC/FFC THICKNESS

0.3 +0.04/-0.01 mm (.012+.002/-0")

REVIEWED : Eisley APPROVED : Sun VERIFIED : Jessie .

ENGINEERING DEPT.		PRODUCT SPECIFICATION For CF41 Series Connector System	SPEC.NO.: SPCF062B
REVISIONS	ECNT120150		PAGE: 2/4

8. ELECTRICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
8.1	Rated current and voltage		0.5A max. 50V AC/DC max.
8.2	Contact resistance	Dry circuit of DC 20 mV max. , 10 mA max.	Less than 30 mΩ
8.3	Dielectric strength	When applied AC 500 V 1 minute between adjacent terminal	No change
8.4	Insulation resistance	When applied DC 500 V between adjacent terminal or ground	More than 500 MΩ

9. MECHANICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
9.1	Contact retaining force in insulator	Retention speed 25 ± 3 mm per minute from housing	More than 0.03 Kgf
9.2	FFC / FPC withdrawal force	Measure force to withdrawal using 0.30 mm thickness FPC / FFC at speed 25 ± 3 mm per minute	$(0.03 \times \text{no. of Contacts})$ Kgf min.
9.3	Durability	Connector shall be subjected to 30 cycles of insertion and withdrawal	No damage Contact resistance: Less than twice of initial

10. ENVIRONMENTAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
10.1	Temperature rise	Then carried the rated current	30 °C max.
10.2	Vibration	1.5 mm 10-55-10 HZ / minute each 2 hours for X , Y and Z directions	Appearance: No damage Discontinuity: 1 micro second max. Contact resistance: Less than twice of initial
10.3	Shock	490m/s ² (50G), 3 strokes in each X.Y.Z. axes.	Appearance: No damage Discontinuity : 1ms. max.

ENGINEERING DEPT.		PRODUCT SPECIFICATION For CF41 Series Connector System	SPEC.NO.: SPCF062B
REVISIONS	ECNT120150		PAGE: 3/4

	ITEM	TEST CONDITION	REQUIREMENT
10.4	Heat aging	85 ± 2 °C , 96 hours	No damage Contact resistance: Less than twice of initial
10.5	Cold aging	-40 ± 2 °C , 96 hours	No damage Contact resistance: Less than twice of initial
10.6	Humidity	40 ± 2 °C , 90-95% RH , 96 hours measurement must be taken within 30 min. after tested	Appearance: No damage Contact resistance: Less than twice of initial Dielectric strength: To pass para 8-3 Insulation resistance : Less than 30MΩ
10.7	Temperature cycling	One cycle consists of : (1) -55 ⁺⁰ ₋₃ °C , 30 min. (2) Room temp. 10-15 min. (3) 85 ⁺³ ₋₀ °C , 30 min. (4) Room temp. 10-15 min.	Appearance: No damage Contact resistance: Less than twice of initial
10.8	Salt spray	Temperature: 35 ± 3 °C Solution: 5 ± 1% Spray time: 48 ± 4 hours (Stamping before plated) Spray time: 24 ± 4 hours (Stamping after plated) Mate connectors and expose to the following salt mist conditions. Upon completion of the exposure period, salt deposits shall be removed by a gentle wash or dip in running water and dried naturally, after which the specified measurements shall be performed. The specimens shall be suspended from the top using waxed twine, string or nylon thread. The test only define the plating area, without plating area (as copper cross section) will not be defined. (EIA 364-26B / MIL-STD-202 Method 101)	Appearance: No damage Contact resistance: Less than twice of initial

ENGINEERING DEPT.		PRODUCT SPECIFICATION For CF41 Series Connector System	SPEC.NO.: SPCF062B
REVISIONS	ECNT120150		PAGE: 4/4

	ITEM	TEST CONDITION	REQUIREMENT
10.9	SO ₂ Gas	24 hours exposure to 50 ± 5ppm. SO ₂ gas at 40 ± 2 °C.	Contact resistance: Less than twice of initial
10.10	NH ₃ Gas	40 minutes exposure to NH ₃ gas evaporating from 28% Ammonia solution.	Appearance: No damage Contact resistance: Less than twice of initial
10.11	Solder ability	Soldering time: 2 ± 0.5 second Soldering pot: 245 ± 5 °C	Minimum: 95% of immersed area
10.12	Resistance to Soldering heat	Soldering time: 10 ± 0.5 second Soldering pot: 260 ± 5 °C	No damage

11. AMBIENT TEMPERATURE RANGE: -25 to +85 °C

12. Recommended IR Reflow Temperature Profile(Lead-Free):

